

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the Application of:

Zuniga-Ortiz, et al

Serial No: 10/057,138

Filed: January 25, 2002

For: Flip-Chip Without Bumps and Polymer for Board Assembly



Docket No.: TI-33986

Art Unit: 2827

Examiner: Thai, Luan C.

Mail Stop RCE

Commissioner for Patents

P.O. Box 1450

Alexandria, Virginia 22313-1450

AMENDMENT AS SUBMISSION FOR REQUEST FOR CONTINUED EXAMINATION

Dear Sir:

In response to the Examiner's Final Office Action mailed April 1, 2004 and Advisory Action mailed June 8, 2004, and as the submission required under 37 C.F.R. § 1.114 for RCE, the period for response being extended to September 1, 2004, by the concurrently filed Petition for Automatic Extension of Time, please amend this application as follows.

Amendments to the Claims are reflected in the listing of claims which begins on page 2 of this paper.

Remarks/Arguments begin on page 11 of this paper.

Date of Deposit: <u>Sept. 1, 2004</u>
I hereby certify under 37 CFR 1.8(a) that this correspondence is being deposited with the United States Postal Service as first class mail with sufficient postage on the date indicated above and is addressed to the Commissioner for Patents, P.O. Box 1450, Alexandria, Virginia 22313-1450.
<u>Indranil Chowdhury</u>
Indranil Chowdhury Reg. No.: 47,490